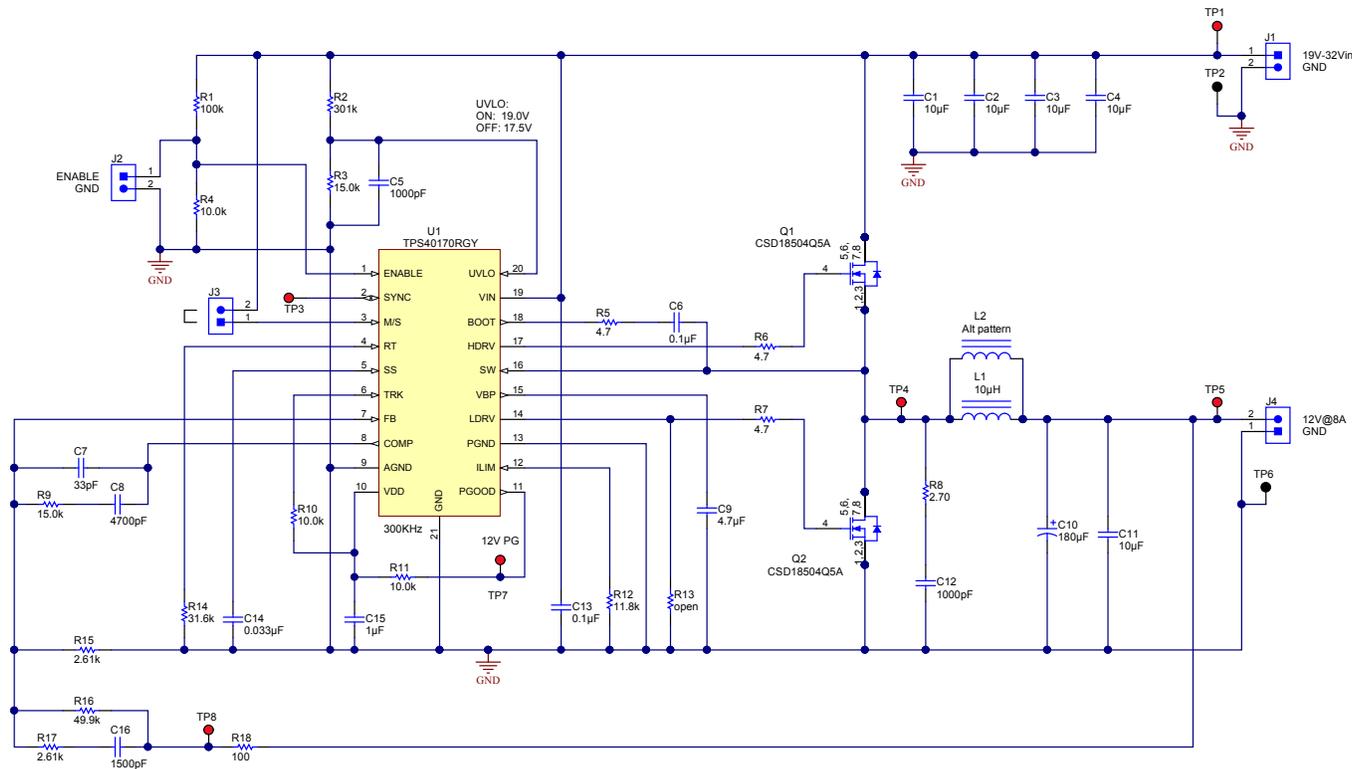


NOTES:
 1) REV B makes the following changes:
 L1 = XAL1510-103
 R12 = 11.8K
 Q1/Q2 = CSD18504Q5A



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Orderable: N/A	Designed for Public Release	Mod. Date: 2/6/2015
TID #:	Project Title: TPS40170 Converter	
Number: PMP10799	Rev: B	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 1
Drawn By:	File: PMP10799 REV B.SchDoc	Size: B
Engineer: J Betten	Contact: http://www.ti.com/support	



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